

# LM26NV

## SOT-23, $\pm 3^{\circ}\text{C}$ Accurate, Factory Preset Thermostat (LM26 without $V_{\text{TEMP}}$ output)

### General Description

The LM26NV is a precision, single digital-output, low-power thermostat comprised of an internal reference, DAC, temperature sensor and comparator. Utilizing factory programming, it can be manufactured with different trip points as well as different digital output functionality. The trip point ( $T_{\text{OS}}$ ) can be preset at the factory to any temperature in the range of  $-55^{\circ}\text{C}$  to  $+110^{\circ}\text{C}$  in  $1^{\circ}\text{C}$  increments. The LM26NV has one digital output ( $\overline{\text{OS}}/\text{OS}/\text{US}/\overline{\text{US}}$ ) and one digital input (HYST). The digital output stage can be preset as either open-drain or push-pull. In addition, it can be factory programmed to be active HIGH or LOW. The digital output can be factory programmed to indicate an over temperature shutdown event ( $\overline{\text{OS}}$  or  $\text{OS}$ ) or an under temperature shutdown event ( $\text{US}$  or  $\overline{\text{US}}$ ). When preset as an overtemperature shutdown ( $\overline{\text{OS}}$ ), it will go LOW to indicate that the die temperature is over the internally preset  $T_{\text{OS}}$  and go HIGH when the temperature goes below ( $T_{\text{OS}} - T_{\text{HYST}}$ ). Similarly, when preprogrammed as an undertemperature shutdown (US) it will go HIGH to indicate that the temperature is below  $T_{\text{US}}$  and go LOW when the temperature is above ( $T_{\text{US}} + T_{\text{HYST}}$ ). The typical hysteresis,  $T_{\text{HYST}}$ , can be set to  $2^{\circ}\text{C}$  or  $10^{\circ}\text{C}$  and is controlled by the state of the HYST pin.

Available parts are detailed in the ordering information. For other part options, contact a National Semiconductor Distributor or Sales Representative for information on minimum order qualification. The LM26NV is currently available in a 5-lead SOT-23 package.

### Applications

- Microprocessor Thermal Management
- Appliances

- Portable Battery Powered Systems
- Fan Control
- Industrial Process Control
- HVAC Systems
- Remote Temperature Sensing
- Electronic System Protection

### Features

- Internal comparator with pin programmable  $2^{\circ}\text{C}$  or  $10^{\circ}\text{C}$  hysteresis
- No external components required
- Open Drain or push-pull digital output; supports CMOS logic levels
- Internal temperature sensor
- Internal voltage reference and DAC for trip-point setting
- Currently available in 5-pin SOT-23 plastic package
- Excellent power supply noise rejection

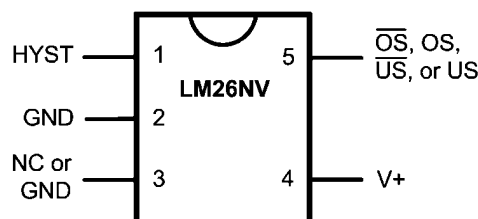
### Key Specifications

- |                          |   |
|--------------------------|---|
| ■ Power Supply Voltage   | 2.7V to 5.5V                                      |
| ■ Power Supply Current   | 40 $\mu\text{A}$ (max)<br>20 $\mu\text{A}$ (typ)  |
| ■ Hysteresis Temperature | $2^{\circ}\text{C}$ or $10^{\circ}\text{C}$ (typ) |

#### Temperature Trip Point Accuracy

Temperature Range	LM26NV
$-55^{\circ}\text{C}$ to $+110^{\circ}\text{C}$	$\pm 3^{\circ}\text{C}$ (max)
$+120^{\circ}\text{C}$	$\pm 4^{\circ}\text{C}$ (max)

### Connection Diagram



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## Pin Descriptions

Pin Number	Pin Name	Function	Connection
1	HYST	Hysteresis control, digital input	GND for 10°C or V+ for 2°C
2	GND	Ground, connected to the back side of the die through lead frame.	System GND
3	NC	Not Connected Inside Part	Ground or No Connect
4	V+	Supply input	2.7V to 5.5V with a 0.1µF bypass capacitor. For PSRR information see <i>Section Titled NOISE CONSIDERATIONS</i> .
5	$\overline{OS}$	Overtemperature Shutdown open-drain active low thermostat digital output	Controller interrupt, system or power supply shutdown; pull-up resistor $\geq 10k\Omega$
	OS	Overtemperature Shutdown push-pull active high thermostat digital output	Controller interrupt, system or power supply shutdown
	$\overline{US}$	Undertemperature Shutdown open-drain active low thermostat digital output	System or power supply shutdown; pull-up resistor $\geq 10k\Omega$
	US	Undertemperature Shutdown push-pull active high thermostat digital output	System or power supply shutdown

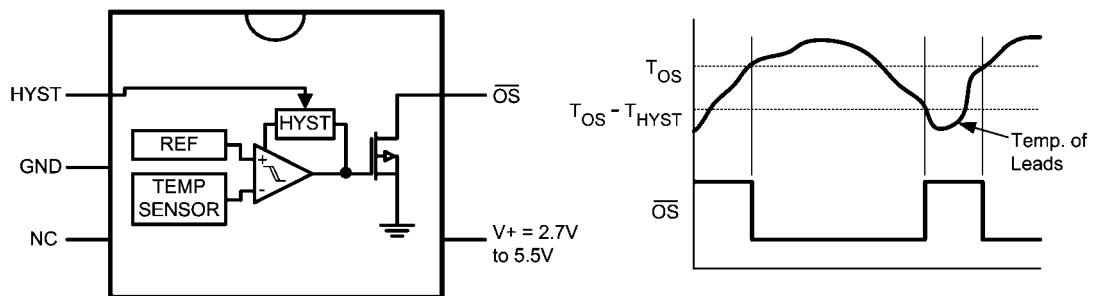
Note: Pin 5 functionality and trip point setting are programmed during LM26NV manufacture.

## Ordering Information

For more detailed information on the suffix meaning see the part number template at the end of the Electrical Characteristics Section. Contact National Semiconductor for other set points and output options.

Order Number		Top Mark	NS Package Number	Trip Point Setting	Output Function
Bulk Rail	3000 Units in Tape & Reel				
LM26CIM5-YPE	LM26CIM5X-YPE	YPE	MA05B	115°C	Active-Low, Open Drain, $\overline{OS}$ Output

## LM26CIM5-YPE Simplified Block Diagram and Connection Diagram



HYST = GND for 10°C Hysteresis  
HYST = V+ for 2°C Hysteresis

**The LM26CIM5-YPE has a fixed trip point of 115°C.  
For other trip point and output function availability,  
please see ordering information or contact National Semiconductor.**

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**Absolute Maximum Ratings** (Note 1)

Input Voltage	6.0V
Input Current at any pin (Note 2)	5mA
Package Input Current (Note 2)	20mA
Package Dissipation at $T_A = 25^\circ\text{C}$ (Note 3)	500mW
Soldering Information	
SOT23 Package	
Vapor Phase (60 seconds)	215°C
Infrared (15 seconds)	220°C

Storage Temperature	-65°C to +150°C
ESD Susceptibility (Note 4)	
Human Body Model	2500V
Machine Model	250V

**Operating Ratings** (Note 1)

Specified Temperature Range	$T_{\text{MIN}} \leq T_A \leq T_{\text{MAX}}$
LM26NV	$-55^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$
Positive Supply Voltage ( $V^+$ )	+2.7V to +5.5V
Maximum $V_{\text{OUT}}$	+5.5V

**LM26NV Electrical Characteristics**

The following specifications apply for  $V^+ = 2.7V_{\text{DC}}$  to  $5.5V_{\text{DC}}$ , and  $V_{\text{TEMP}}$  load current =  $0\mu\text{A}$  unless otherwise specified. **Boldface limits apply for  $T_A = T_J = T_{\text{MIN}}$  to  $T_{\text{MAX}}$** ; all other limits  $T_A = T_J = 25^\circ\text{C}$  unless otherwise specified.

Symbol	Parameter	Conditions	Typical (Note 6)	LM26NV Limits (Note 7)	Units (Limits)
<b>Temperature Sensor</b>					
	Trip Point Accuracy (Includes $V_{\text{REF}}$ , DAC, Comparator Offset, and Temperature Sensitivity errors)	$-55^\circ\text{C} \leq T_A \leq +110^\circ\text{C}$		±3	°C (max)
		+120°C		±4	°C (max)
	Trip Point Hysteresis	HYST = GND	11		°C
		HYST = $V^+$	2		°C
$I_S$	Supply Current		16	20 <b>40</b>	$\mu\text{A}$ (max) $\mu\text{A}$ (max)
<b>Digital Output and Input</b>					
$I_{\text{OUT}}(^{\text{“1”}})$	Logical “1” Output Leakage Current (Note 9)	$V^+ = +5.0\text{V}$	0.001	1	$\mu\text{A}$ (max)
$V_{\text{OUT}}(^{\text{“0”}})$	Logical “0” Output Voltage	$I_{\text{OUT}} = +1.2\text{mA}$ and $V^+ \geq 2.7\text{V}$ ; $I_{\text{OUT}} = +3.2\text{mA}$ and $V^+ \geq 4.5\text{V}$ ; (Note 8)		<b>0.4</b>	V (max)
$V_{\text{OUT}}(^{\text{“1”}})$	Logical “1” Push-Pull Output Voltage	$I_{\text{SOURCE}} = 500\mu\text{A}$ , $V^+ \geq 2.7\text{V}$		<b><math>0.8 \times V^+</math></b>	V (min)
		$I_{\text{SOURCE}} = 800\mu\text{A}$ , $V^+ \geq 4.5\text{V}$		<b><math>V^+ - 1.5</math></b>	V (min)
$V_{\text{IH}}$	HYST Input Logical “1” Threshold Voltage			<b><math>0.8 \times V^+</math></b>	V (min)
$V_{\text{IL}}$	HYST Input Logical “0” Threshold Voltage			<b><math>0.2 \times V^+</math></b>	V (max)

**Note 1:** Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

**Note 2:** When the input voltage ( $V_i$ ) at any pin exceeds the power supply ( $V_i < \text{GND}$  or  $V_i > V^+$ ), the current at that pin should be limited to 5mA. The 20mA maximum package input current rating limits the number of pins that can safely exceed the power supplies with an input current of 5mA to four. Under normal operating conditions the maximum current that pins 2, 4 or 5 can handle is limited to 5mA each.

**Note 3:** The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{Jmax}$  (maximum junction temperature),  $\theta_{JA}$  (junction to ambient thermal resistance) and  $T_A$  (ambient temperature). The maximum allowable power dissipation at any temperature is  $P_D = (T_{Jmax} - T_A) / \theta_{JA}$  or the number given in the Absolute Maximum Ratings, whichever is lower. For this device,  $T_{Jmax} = 150^\circ\text{C}$ . For this device the typical thermal resistance ( $\theta_{JA}$ ) of the different package types when board mounted follow:

Package Type	$\theta_{JA}$
SOT23-5, MA05B	250°C/W

**Note 4:** The human body model is a 100pF capacitor discharge through a 1.5k $\Omega$  resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

**Note 5:** See the URL "<http://www.national.com/packaging/>" for other recommendations and methods of soldering surface mount devices.

**Note 6:** Typicals are at  $T_J = T_A = 25^\circ\text{C}$  and represent most likely parametric norm.

**Note 7:** Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

**Note 8:** Care should be taken to include the effects of self heating when setting the maximum output load current. The power dissipation of the LM26NV would increase by 1.28mW when  $I_{OUT}=3.2\text{mA}$  and  $V_{OUT}=0.4\text{V}$ . With a thermal resistance of 250°C/W, this power dissipation would cause an increase in the die temperature of about 0.32°C due to self heating. Self heating is not included in the trip point accuracy specification.

**Note 9:** The 1 $\mu\text{A}$  limit is based on a testing limitation and does not reflect the actual performance of the part. Expect to see a doubling of the current for every 15°C increase in temperature. For example, the 1nA typical current at 25°C would increase to 16nA at 85°C.

## Part Number Template

The series of characters labeled "xyz" in the part number LM26CIM5-xyz, describe the set point value and the function of the output. The character at "x" and "y" define the set point temperature (at which the digital output will go active). The "z" character defines the type and function of the digital output. These place holders are defined in the following tables.

The place holders xy describe the set point temperature as shown in the following table.

x (10x)	y (1x)	Temperature (°C)
A	-	-5
B	-	-4
C	-	-3
D	-	-2
E	-	-1
F	-	-0

x (10x)	y (1x)	Temperature (°C)
H	H	0
J	J	1
K	K	2
L	L	3
N	N	4
P	P	5
R	R	6
S	S	7
T	T	8
V	V	9
X	-	10
Y	-	11
Z	-	12

The value of z describes the assignment/function of the output as shown in the following table:

Active-Low/High	Open-Drain/ Push-Pull	$\overline{OS}/US$	Value of z	Digital Output Function
0	0	0	E	Active-Low, Open-Drain, $\overline{OS}$ output
0	0	1	F	Active-Low, Open-Drain, $\overline{US}$ output
1	1	0	G	Active-High, Push-Pull, OS output
1	1	1	H	Active-High, Push-Pull, US output

### EXAMPLE:

- The part number LM26CIM5-YPE has  $T_{OS} = 115^{\circ}\text{C}$ , and has an active-low open-drain overtemperature shutdown output. The "Y" represents the tens value "11", the "P" represents the ones value "5", and the "E" means that the

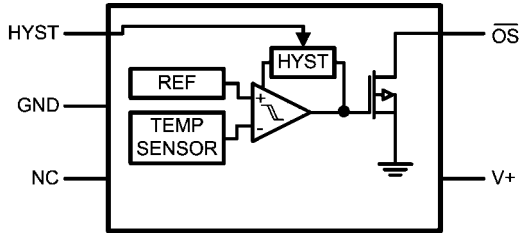
output will be an active-low, open-drain, over-temperature output.

Many active-high open-drain and active-low push-pull options are available, please contact National Semiconductor for more information.

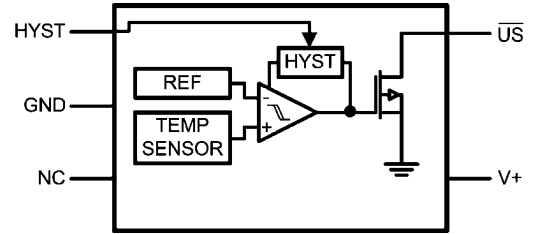
# Functional Description

## LM26NV OPTIONS

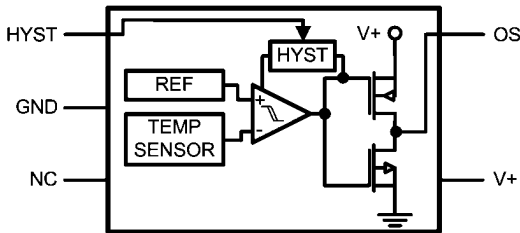
The LM26NV can be factory programmed to have a trip point anywhere in the range of  $-55^{\circ}\text{C}$  to  $+110^{\circ}\text{C}$ . It is also available in any of four output options, as indicated by the last letter in the part number.



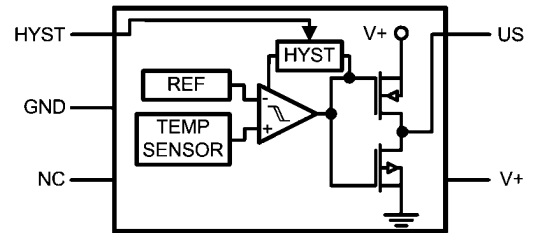
LM26CIM5 - \_\_E: The "E" indicates that the digital output is Active-Low Open-Drain and will trip as temperature is rising (OS) 30075112



LM26CIM5 - \_\_F: The "F" indicates that the digital output is Active-Low Open-Drain and will trip as temperature is falling (US) 30075113



LM26CIM5 - \_\_G: The "G" indicates that the digital output is Active-High Push-Pull and will trip as temperature is rising (OS) 30075114



LM26CIM5 - \_\_H: The "H" indicates that the digital output is Active-High Push-Pull and will trip as temperature is falling (US) 30075115

FIGURE 1. Output Pin Options Block Diagrams

## Applications Hints

### NOISE CONSIDERATIONS

The LM26NV has excellent power supply noise rejection. Listed below is a variety of signals used to test the LM26NV power supply rejection. False triggering of the output was not observed when these signals were coupled into the V+ pin of the LM26NV.

- square wave 400kHz, 1Vp-p
- square wave 2kHz, 200mVp-p
- sine wave 100Hz to 1MHz, 200mVp-p

Testing was done while maintaining the temperature of the LM26NV one degree centigrade away from the trip point with the output not activated.

### MOUNTING CONSIDERATIONS

The LM26NV can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface. The temperature that the LM26NV is sensing will be within about +0.06°C of the surface temperature to which the LM26NV's leads are attached to.

This presumes that the ambient air temperature is almost the same as the surface temperature; if the air temperature were much higher or lower than the surface temperature, the actual temperature measured would be at an intermediate temperature between the surface temperature and the air temperature.

To ensure good thermal conductivity, the backside of the LM26NV die is directly attached to the GND pin (pin 2). The temperatures of the lands and traces to the other leads of the LM26NV will also affect the temperature that is being sensed.

Alternatively, the LM26NV can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed

into a threaded hole in a tank. As with any IC, the LM26NV and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. Printed-circuit coatings and varnishes such as Humiseal and epoxy paints or dips are often used to ensure that moisture cannot corrode the LM26NV or its connections.

The junction to ambient thermal resistance ( $\theta_{JA}$ ) is the parameter used to calculate the rise of a part's junction temperature due to its power dissipation. For the LM26NV the equation used to calculate the rise in the die junction temperature is as follows:

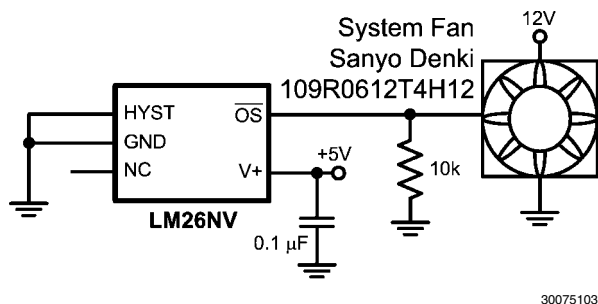
$$T_J = T_A + \theta_{JA}(V^+I_Q + V_{DO}I_{DO}) \quad (1)$$

where  $T_A$  is the ambient temperature,  $V^+$  is the power supply voltage,  $I_Q$  is the quiescent current,  $V_{DO}$  is the voltage on the digital output, and  $I_{DO}$  is the load current on the digital output. The tables shown in [Figure 2](#) summarize the thermal resistance for different conditions and the rise in die temperature of the LM26NV and a 10k pull-up resistor on an open-drain digital output with a 5.5V power supply.

	SOT23-5 no heat sink		SOT23-5 small heat sink	
	$\theta_{JA}$ (°C/W)	$T_J - T_A$ (°C)	$\theta_{JA}$ (°C/W)	$T_J - T_A$ (°C)
Still Air	250	0.11	TBD	TBD
Moving Air	TBD	TBD	TBD	TBD

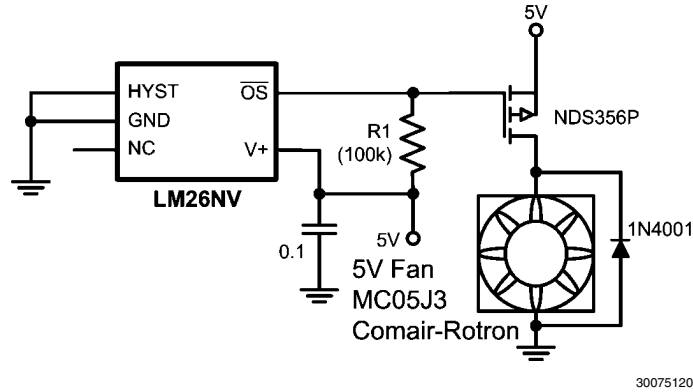
FIGURE 2. Thermal resistance ( $\theta_{JA}$ ) and temperature rise due to self heating ( $T_J - T_A$ )

## Typical Applications



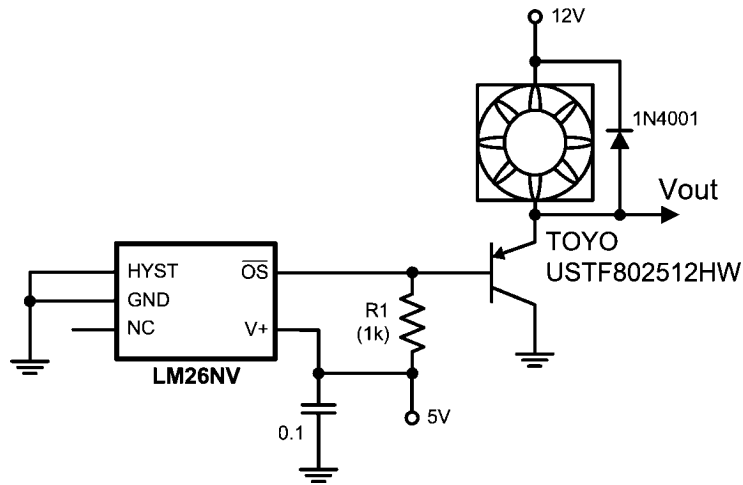
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FIGURE 3. Two Speed Fan Speed Control: The fan's control pin has an internal pull-up. The 10 kOhm pull-down sets a slow fan speed. When the output of the LM26NV goes low, the fan will speed up.



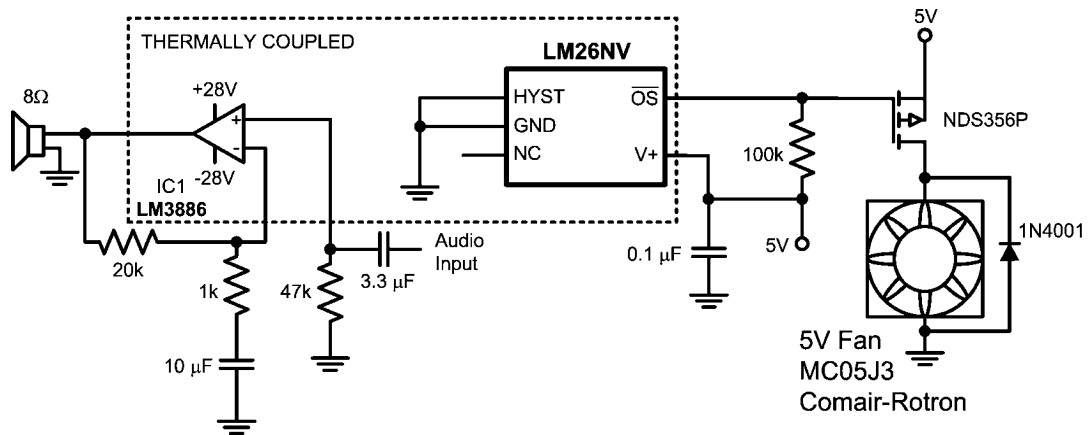
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FIGURE 4. Fan High Side Drive: The LM26NV switches the fan on when the measured temperature exceeds the trip temperature.



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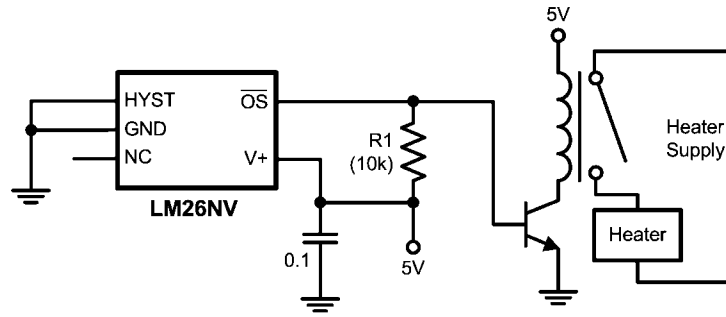
FIGURE 5. Fan Low Side Drive: The LM26LV sinks causes the switch to sink the fan current when the measured temperature exceeds the trip temperature.



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FIGURE 6. Audio Power Amplifier Thermal Protection: By thermally coupling the LM26NV to the audio power amplifier, the LM26NV safeguards the amplifier from overheating, turning on the fan when it temperature exceeds the trip temperature.

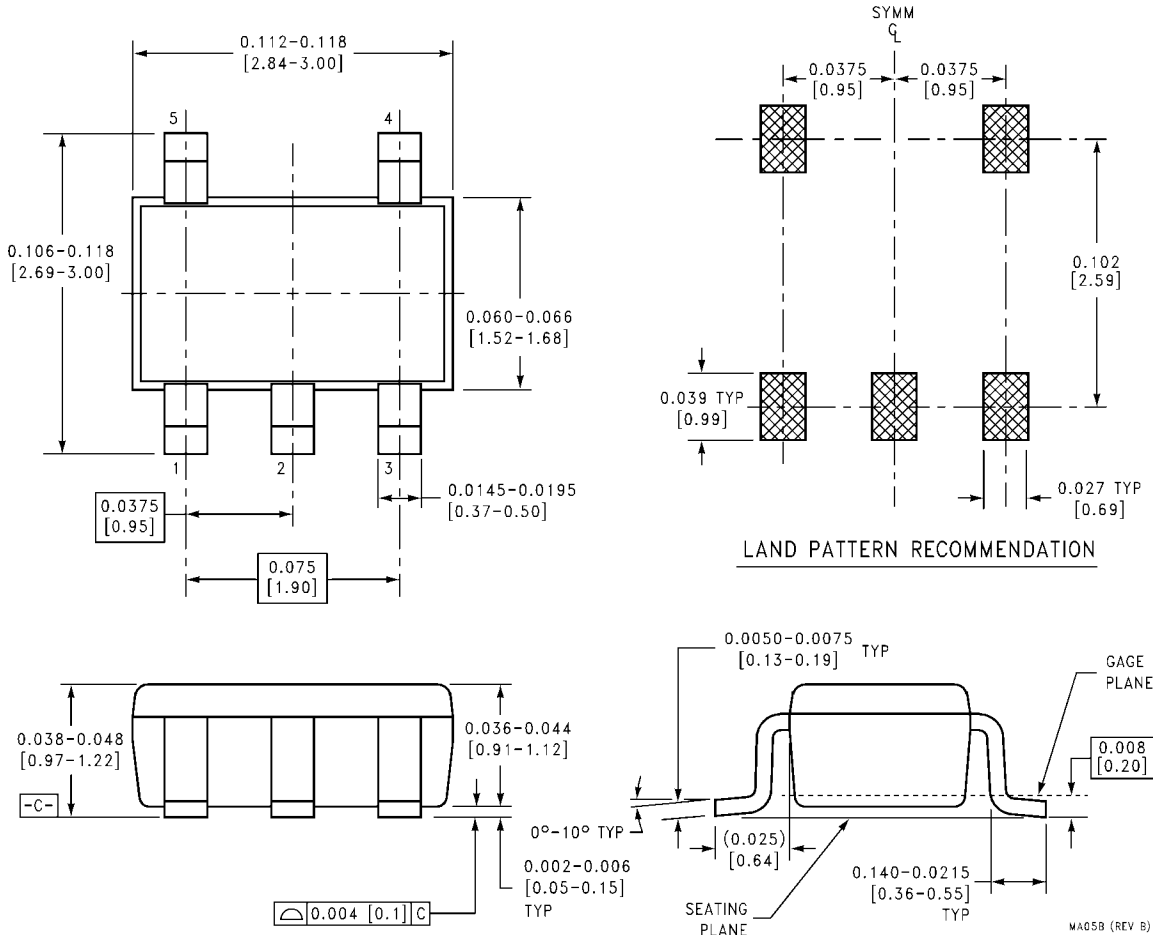




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**FIGURE 7. Simple Thermostat:** When the measured temperature is below the trip temperature of the LM26NV, the  $\overline{OS}$  output will be high, causing the switch and relay to close. When the temperature exceeds the trip point,  $\overline{OS}$  goes low and shuts off the relay and heater.

**Physical Dimensions** inches (millimeters) unless otherwise noted



**5-Lead Molded SOT-23 Plastic Package, JEDEC**  
**Order Number LM26CIM5-\_\_ E or LM26CIM5X-\_\_ E;**  
**LM26CIM5-\_\_ F or LM26CIM5X-\_\_ F; LM26CIM5-\_\_ G or LM26CIM5X-\_\_ G;**  
**LM26CIM5-\_\_ H or LM26CIM5X-\_\_ H**  
**NS Package Number MA05B**

# Notes

## Notes

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Interface	<a href="http://www.national.com/interface">www.national.com/interface</a>	Eval Boards	<a href="http://www.national.com/evalboards">www.national.com/evalboards</a>
LVDS	<a href="http://www.national.com/lvds">www.national.com/lvds</a>	Packaging	<a href="http://www.national.com/packaging">www.national.com/packaging</a>
Power Management	<a href="http://www.national.com/power">www.national.com/power</a>	Green Compliance	<a href="http://www.national.com/quality/green">www.national.com/quality/green</a>
Switching Regulators	<a href="http://www.national.com/switchers">www.national.com/switchers</a>	Distributors	<a href="http://www.national.com/contacts">www.national.com/contacts</a>
LDOs	<a href="http://www.national.com/ldo">www.national.com/ldo</a>	Quality and Reliability	<a href="http://www.national.com/quality">www.national.com/quality</a>
LED Lighting	<a href="http://www.national.com/led">www.national.com/led</a>	Feedback/Support	<a href="http://www.national.com/feedback">www.national.com/feedback</a>
Voltage References	<a href="http://www.national.com/vref">www.national.com/vref</a>	Design Made Easy	<a href="http://www.national.com/easy">www.national.com/easy</a>
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Serial Digital Interface (SDI)	<a href="http://www.national.com/sdi">www.national.com/sdi</a>	Mil/Aero	<a href="http://www.national.com/milaero">www.national.com/milaero</a>
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